



Product Change Notification

112911 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112911 - 00
Change Title: Boxed Intel® NUC Kit BOXDC53427HYE,
Intel® NUC Board BLKD53427RKE,
Intel® NUC Kit BLKDC53427HYE
PCN 112911-00, Product Design
Lock Trusted Platform Module
Date of Publication: March 3, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Mar 31, 2014
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Description of Change to the Customer:

The non-volatile memory of the Trusted Platform Module (TPM) has been locked to support Intel® Trusted Execution Technology (Intel® TXT).

Customer Impact of Change and Recommended Action:

These changes have been evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BLKD53427RKE	927919		G87790-403		G87790-404
BOXDC53427HYE	927920	H10106-101		H10106-102	
BLKDC53427HYE	930170	G87963-102		G87963-103	

PCN Revision History:

Date of Revision: March 3, 2014	Revision Number: 00	Reason: Originally Published PCN
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